

NCE N-Channel Super Trench Power MOSFET

Description

The NCEP85T25VD uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{\text{DS}(\text{ON})}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

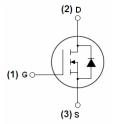
General Features

- $V_{DS} = 85V, I_D = 250A$
 - $R_{DS(ON)}$ <2.0m Ω @ V_{GS} =10V
- Excellent gate charge x R_{DS(on)} product
- Very low on-resistance R_{DS(on)}
- 175 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

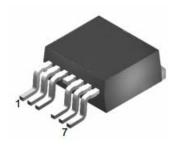
100% UIS TESTED! 100% ΔVds TESTED!



Schematic diagram



Marking and pin assignment



TO-263-7L top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP85T25VD	NCEP85T25VD	TO-263-7L	-	-	-

Absolute Maximum Ratings (T_C=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	85	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous	I _D	250	А
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	180	А
Pulsed Drain Current	I _{DM}	1000	Α
Maximum Power Dissipation	P _D	300	W
Derating factor		2	W/℃
Single pulse avalanche energy (Note 5)	E _{AS}	2000	mJ
Operating Junction and Storage Temperature Range	T_{J} , T_{STG}	-55 To 175	$^{\circ}$

Thermal Characteristic

Thermal Resistance,Junction-to-Case ^(Note 2)	R _{θJC}	0.5	°C/W
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Electrical Characteristics (T_C=25 [°]C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	85		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =85V,V _{GS} =0V	-	-	1	μΑ
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20 V , V_{DS} =0 V	-	-	±100	nA
On Characteristics (Note 3)			•			
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	2.5	3.5	4.5	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =100A	-	1.7	2.0	mΩ
Forward Transconductance	g FS	V _{DS} =10V,I _D =100A	-	90	-	S
Dynamic Characteristics (Note4)			1			
Input Capacitance	C _{lss}		-	10700	-	PF
Output Capacitance	C _{oss}	V_{DS} =40V, V_{GS} =0V,	-	1700	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	76	-	PF
Switching Characteristics (Note 4)			1			
Turn-on Delay Time	t _{d(on)}		-	28	-	nS
Turn-on Rise Time	t _r	V_{DD} =40V, I_{D} =100A V_{GS} =10V, R_{G} =1.6 Ω	-	73	-	nS
Turn-Off Delay Time	t _{d(off)}		-	86	-	nS
Turn-Off Fall Time	t _f		-	33	-	nS
Total Gate Charge	Qg	\/ 40\/ L 400A	-	142		nC
Gate-Source Charge	Q _{gs}	V _{DS} =40V,I _D =100A,	-	56		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	24		nC
Drain-Source Diode Characteristics	1					
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _F = I _S	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	250	А
Reverse Recovery Time	t _{rr}	$T_J = 25^{\circ}C$, $I_F = I_S$	-	115		nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	320		nC

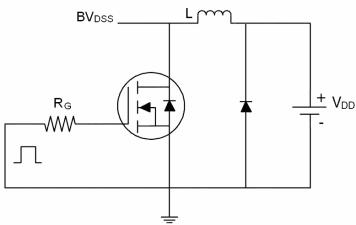
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25 $^{\circ}\text{C}$,VDD=42.5V,VG=10V,L=0.5mH,Rg=25 Ω

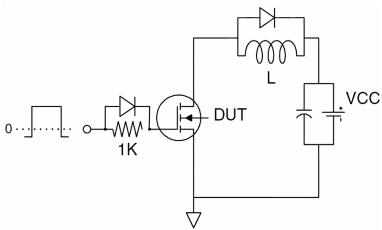


Test Circuit

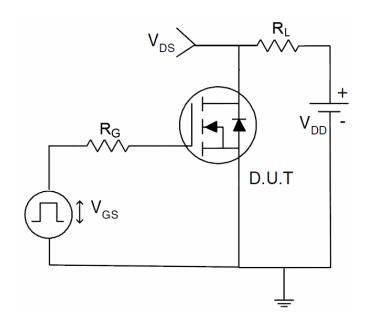
1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit





Typical Electrical and Thermal Characteristics

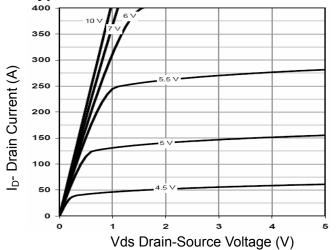


Figure 1 Output Characteristics

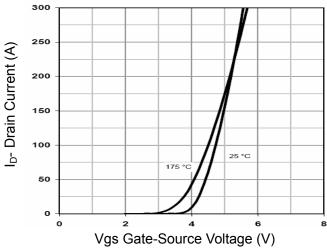


Figure 2 Transfer Characteristics

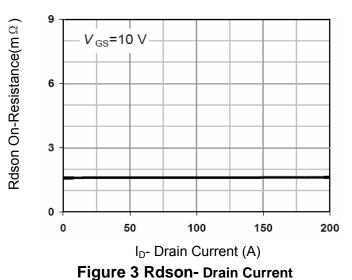


Figure 4 Rdson-JunctionTemperature

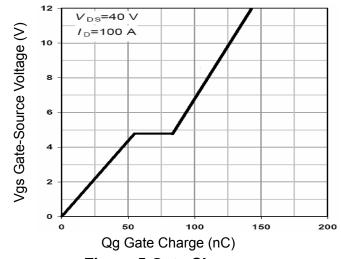


Figure 5 Gate Charge

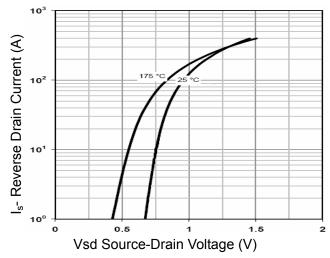
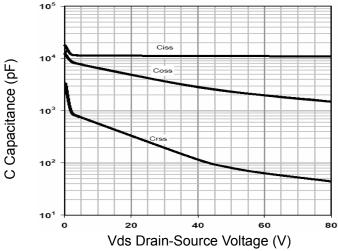


Figure 6 Source- Drain Diode Forward





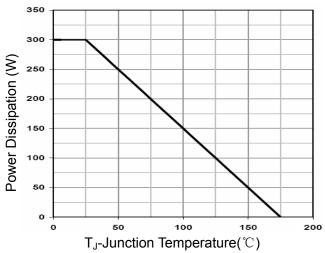
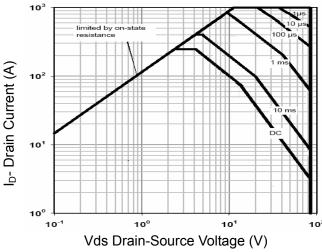


Figure 7 Capacitance vs Vds

Figure 9 Power De-rating



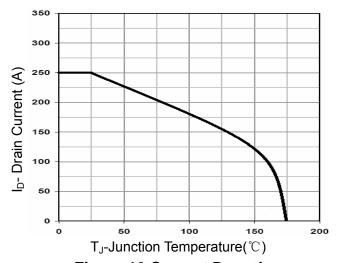


Figure 8 Safe Operation Area

Figure 10 Current De-rating

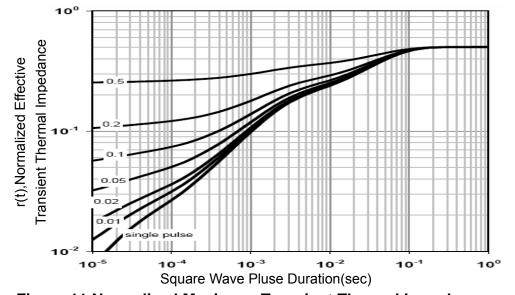
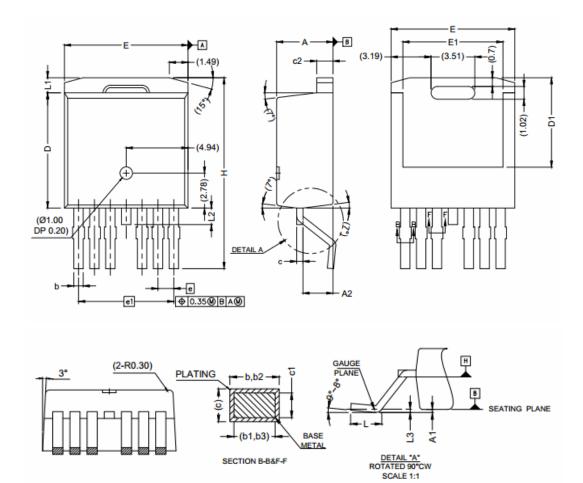


Figure 11 Normalized Maximum Transient Thermal Impedance



TO-263-7L Package Information



SYMBOL	MIN	MAX	
Α	4.30	4.70	
A1	-	0.254	
A2	2.20	2.60	
b	0.65	0.85	
b1	0.65	0.80	
b2	0.80	1.00	
b3	0.80	0.95	
С	0.45	0.60	
c1	0.45	0.55	
c2	1.25	1.40	
D	9.00	9.40	
D1	6.86	7.42	
E	9.68	10.08	
E1	7.70	8.30	
е	1.27 BSC		
e1	7.62 BSC		
L	1.78	2.79	
L1	-	1.60	
L2	- 1.78		
L3	0.25BSC		
Н	14.61	15.88	



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